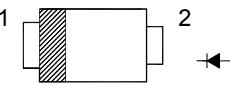


# 1N5817HS THRU 1N5819HS

**Surface Mount Schottky Barrier Rectifier**  
**Reverse Voltage - 20 to 40 V**  
**Forward Current - 1 A**

## PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode



Top View  
 Marking Code: 1N5817HS:SK  
 1N5818HS~1N5819HS:SL  
 Simplified outline SOD-323HE and symbol

## Absolute Maximum Ratings and Characteristics

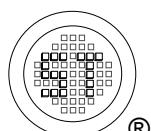
Ratings at 25°C ambient temperature unless otherwise specified, single phase, half wave, resistive or inductive load. For capacitive load, derate by 20%

Parameter	Symbols	1N5817HS	1N5818HS	1N5819HS	Units
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	20	30	40	V
Maximum RMS Voltage	$V_{RMS}$	14	21	28	V
Maximum DC Blocking Voltage	$V_{DC}$	20	30	40	V
Maximum Average Forward Rectified Current	$I_{F(AV)}$		1		A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load(JEDEC methode)	$I_{FSM}$		25		A
Maximum Instantaneous Forward Voltage at $I_F = 1 \text{ A}$ at $I_F = 3 \text{ A}$	$V_F$	0.45 0.75	0.55 0.875	0.6 0.9	V
Maximum Instantaneous Reverse Current at Rated DC Blocking Voltage <sup>1)</sup> $T_A = 25^\circ\text{C}$ $T_A = 100^\circ\text{C}$	$I_R$		0.5 10		mA
Typical Junction Capacitance <sup>2)</sup>	$C_J$		110		pF
Typical Thermal Resistance, Junction to Ambient <sup>3)</sup>	$R_{\theta JA}$		75		°C/W
Operating Junction Temperature Range	$T_j$		- 55 to + 125		°C
Storage Temperature Range	$T_{stg}$		- 55 to + 150		°C

<sup>1)</sup> Pulse test: 300 µs pulse width, 1% duty cycle

<sup>2)</sup> Measured at 1 MHz and reverse voltage of 4 V

<sup>3)</sup> Thermal resistance junction to ambient 0.24" X 0.24"(6 X 6 mm) copper pads to each terminals



# 1N5817HS THRU 1N5819HS

Fig 1. Forward Current Derating Curve

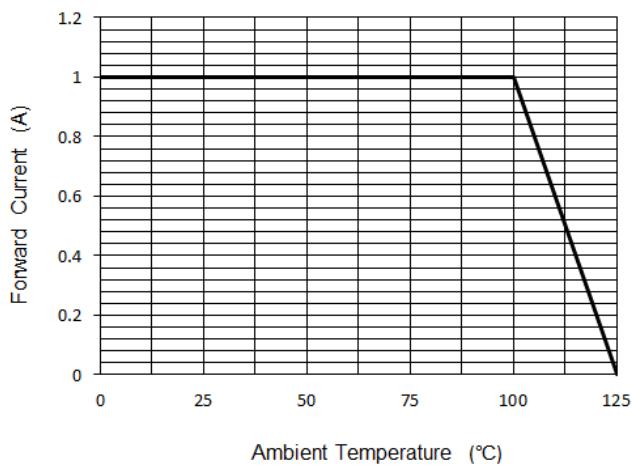


Fig 2. Junction Capacitance Reverse Voltage

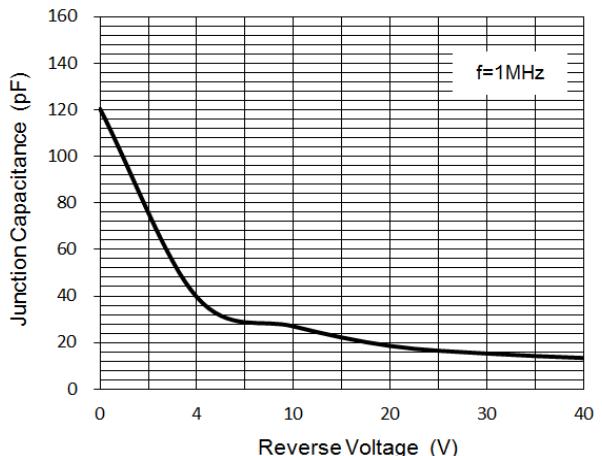
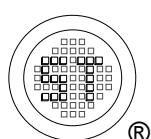
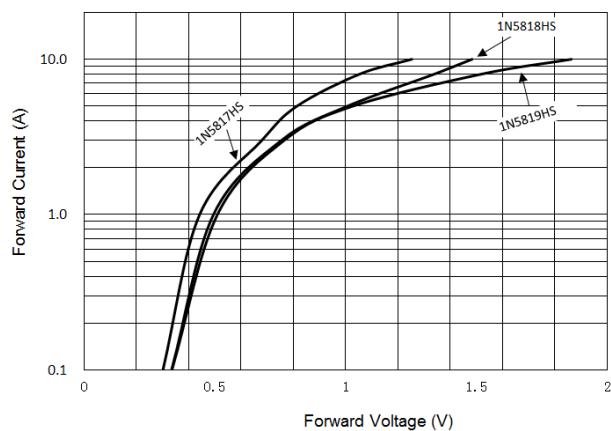


Fig 3. Forward Characteristics

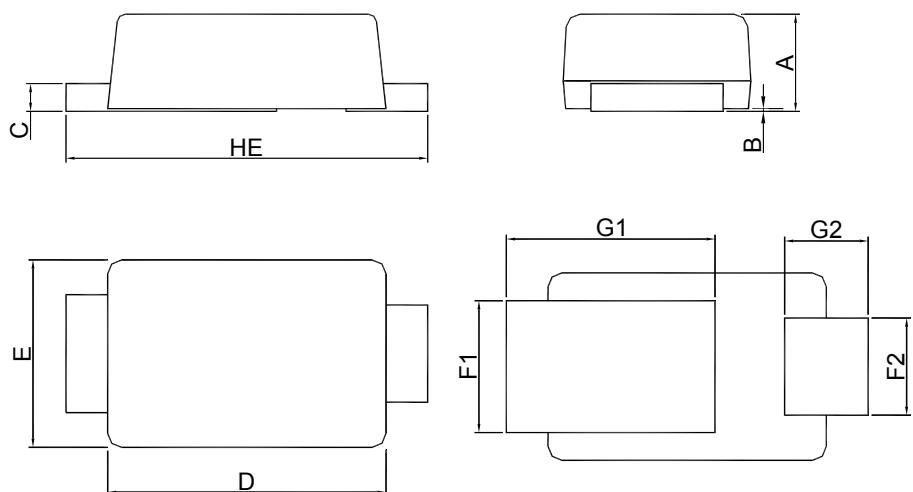


# 1N5817HS THRU 1N5819HS

## PACKAGE OUTLINE

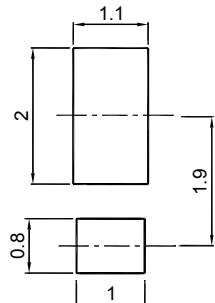
Plastic surface mounted package; 2 leads

SOD-323HE



UNIT	A	B	C	D	E	F1	F2	G1	G2	H <sub>E</sub>
mm	0.7	0.02	0.2	2	1.35	0.95	0.7	1.5	0.6	2.6
	0.5	0	0.1	1.8	1.15	0.75	0.5	1.3	0.4	2.4

## Recommended Soldering Footprint



## Packing information

Package	Tape Width (mm)	Pitch		Reel Size		Per Reel Packing Quantity
		mm	inch	mm	inch	
SOD-323HE	8	4 ± 0.1	0.157 ± 0.004	178	7	3,000

## Marking information

" III " = Cathode line

" \*\* " = Part No.

Font type: Arial

